TOSHIBA Intelligent Power Device Silicon Monolithic Power MOS Integrated Circuit

TPD1024S

Low-side Power Switch for Motors, Solenoids, and Lamp Drivers

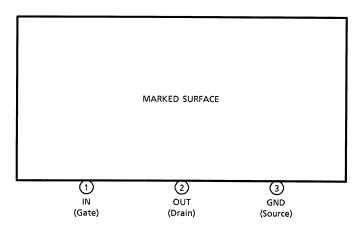
The TPD1024S is a monolithic power IC for low-side switches. The IC has a vertical MOS FET output which can be directly driven from a CMOS or TTL logic circuit (e.g., an MPU).

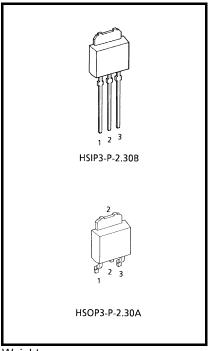
The device is equipped with an intelligent self-protection function.

Features

- A monolithic power IC with a new structure combining a control block and a vertical power MOS FET (π -MOS) on a single chip
- Can directly drive a power load from a CMOS logic.
- Built-in protection against overvoltage, load short-circuiting, and thermal shutdown
- Low on-resistance : RDS (ON) = 0.5 Ω (max), (@VIN = 5 V, T_j = 25°C)
- 3-pin power-molded package usable for surface mounting.

Pin Assignment



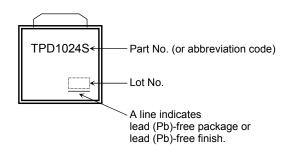


Weight HSIP3-P-2.30B :

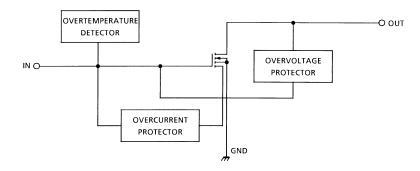
HSIP3-P-2.30B : 0.36 g (typ.) HSOP3-P-2.30A : 0.28 g (typ.)

Note: Due to its MOS structure, this product is sensitive to static electricity.

Marking



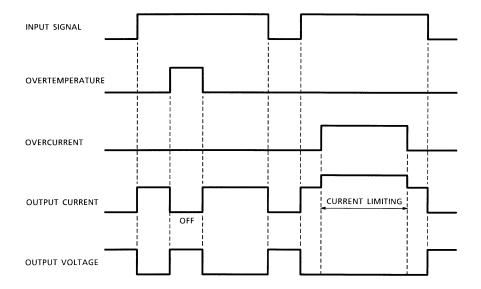
Block Diagram



Pin Description

Pin No.	Symbol	Function
1	IN	Input pin. Input is CMOS-compatible, with pull-down resistor connected. Even if the input is open, output will not accidentally turn on.
2	OUT	Output pin. When current in excess of the typical current (3.5 A (typ.)) flows to the output pin, the current limiter operates to protect the IC.
3	GND	Ground pin.

Timing Chart



Absolute Maximum Ratings (Ta = 25°C)

Characteri	stic	Symbol	Rating	Unit	
Drain-source voltage		V _{DS (DC)}	40	V	
Output current		I _D	1.5	Α	
Input voltage		V_{GS}	-0.5 ~ 6	V	
Power dissipation	Ta = 25°C	PD	1	W	
Fower dissipation	Tc = 25°C	۲۵	10		
Operating temperature		T _{opr}	− 40 ~ 85	°C	
Junction temperature		Tj	150	°C	
Storage temperature		T _{stg}	− 55 ~ 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

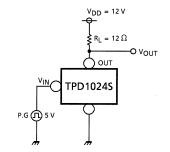
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

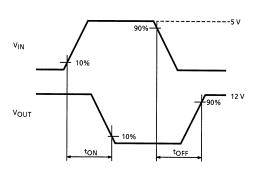
Electrical Characteristics (T_i = 25°C)

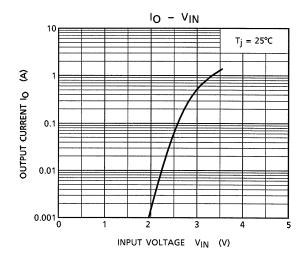
Characteristic	Symbol	Test Cir- cuit	Test Condition	Min	Тур.	Max	Unit
Drain-source breakdown voltage	V _{(BR) DSS}	_	V _{GS} = 0, I _D = 10 mA	40	_	_	V
Operating supply voltage	V _{DD} (OPR)	_	_	_	_	18	V
Current at output off	I _{DSS (1)}	_	V _{GS} = 0, V _{DS} = 40 V	_	_	3	mA
Current at output on	I _{DSS (2)}	_	V _{GS} = 0, V _{DS} = 24 V	_	_	100	μΑ
Input threshold voltage	V _{th}	_	V _{DS} = 10 V, I _D = 1 mA	8.0	_	2.5	V
Input current	IGSS	_	V _{GS} = 5 V, at normal operation	_	_	300	μΑ
On resistance	R _{DS} (ON)	_	V _{GS} = 5 V, I _D = 1 A	_	_	0.5	Ω
Thermal shutdown temperature	T _S	_	_	_	160	_	°C
Overcurrent protection	IS	_	V _{DS} = 12 V, V _{GS} = 5 V	_	3.5	_	Α
Switching time	t _{ON}	1	V _{DS} = 12 V, V _{GS} = 5 V, R _L = 12 Ω	_	50	_	μs
Switching time	t _{OFF}			_	10	_	μs
Diode forward voltage Between drain and source	V _{DSF}	_	I _F = 1.5 A	_	0.9	1.8	V
Avalanche energy	E _A	_	L = 10 mH, Single pulse	30	_	_	mJ

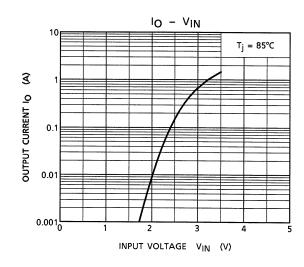
Test Circuit 1

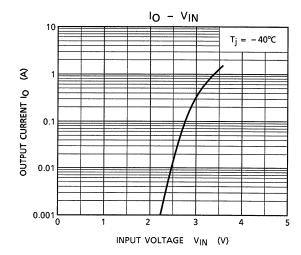
Switching Time

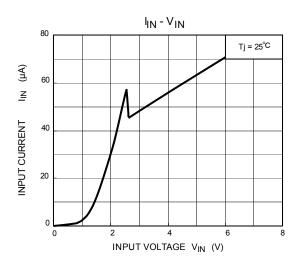


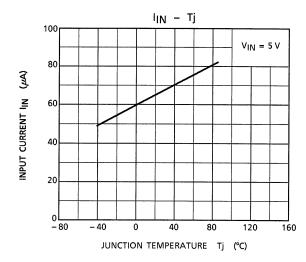


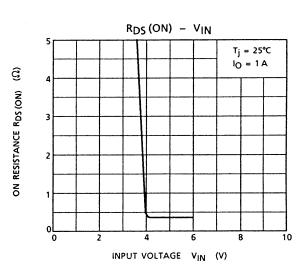




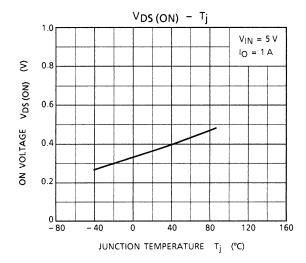


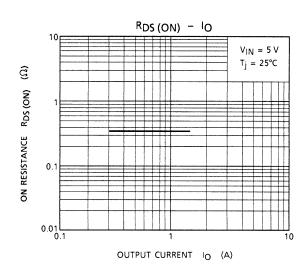


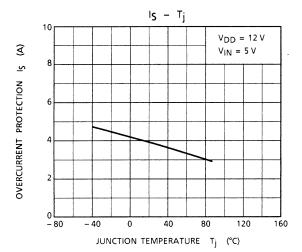


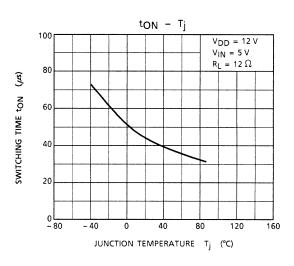


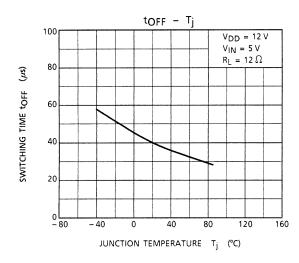
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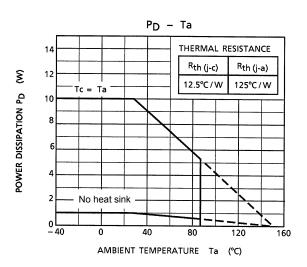






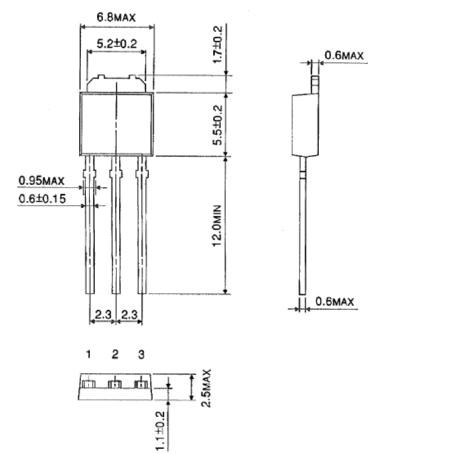






Package Dimensions





Weight: 0.36 g (typ.)

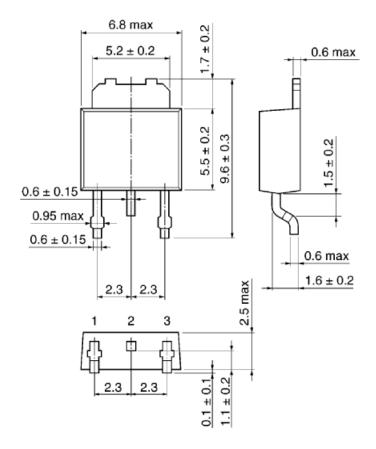
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TPD1024S



Package Dimensions

HSOP3_P_2.30A Unit: mm



Weight: 0.28 g (typ.)

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20070701-EN

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